



# Surface Mount Superfast Rectifiers

#### **Features**

- Low profile space
- Ideal for automated placement
- Glass passivated chip junctions
- Low forward voltage drop
- Low leakage current
- · High forward surge capability
- High temperature soldering:
  260°C/10 seconds at terminals
- Component in accordance to RoHS 2002/95/1 and WEEE 2002/96/EC





SOD-123FL

## **Mechanical Date**

 Case: SOD-123FL molded plastic body over glass passivated chip

 Terminals: Solder plated, solderable per JESD22-B102

• Polarity: Laser band denotes cathode end

• Weight: 0.017gram

### **Major Ratings and Characteristics**

I <sub>F(AV)</sub>	1.0A				
V <sub>RRM</sub>	50 V to 600 V				
I <sub>FSM</sub>	25A				
I <sub>R</sub>	5 μΑ				
V <sub>F</sub>	0.95V, 1.25V, 1.70V				
T <sub>j</sub> max.	150 °C				

## Maximum Ratings & Thermal Characteristics

(T<sub>A</sub> = 25 °C unless otherwise noted)

Items	Symbol	ES 1A	DSK 1B	ES 1C	ES 1D	ES 1E	ES 1G	ES 1J	UNIT
Maximum repetitive peak reverse voltage	$V_{RRM}$	50	100	150	200	300	400	600	V
Maximum RMS voltage	$V_{RMS}$	35	70	105	140	210	280	420	V
Maximum DC blocking voltage	$V_{DC}$	50	100	150	200	300	400	600	V
Maximum average forward rectified current	$I_{F(AV)}$	1.0						Α	
Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load	I <sub>FSM</sub>	25					Α		
Thermal resistance from junction to ambient <sup>(1)</sup>	$R_{\theta JA}$	150					°C/W		
Operating junction and storage temperature range	T <sub>J</sub> , T <sub>STG</sub>	−55 to +150						$^{\circ}\!$	

Note 1: Mounted on P.C.B. with 0.036 x 0.06" (0.9 x 1.5mm) copper pad areas.

### **Electrical Characteristics** (T<sub>A</sub> = 25 °C unless otherwise noted)

Items	Test conditions		Symbol	ES1A~1D	ES1E~1G	ES1J	UNIT
Instantaneous forward voltage	I <sub>F</sub> =1.0A <sup>(2)</sup>		$V_{F}$	0.95	1.25	1.70	V
Reverse current	V <sub>R</sub> =V <sub>DC</sub>	T <sub>j</sub> =25℃	I <sub>R</sub>		μА		
		T <sub>j</sub> =125℃					
Reverse recovery time	$I_F = 0.5 \text{ A}$ , $I_R = 1.0 \text{ A}$ , $I_{rr} = 0.25 \text{ A}$		t <sub>rr</sub>		nS		

Note 2: Pulse test:300µs pulse width,1% duty cycle.

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## Characteristic Curves ( $T_A$ =25 $^{\circ}$ C unless otherwise noted)

Fig.1 Forward Current Derating Curve

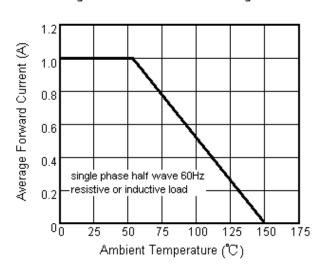


Fig.2 Maximum Non-Repetitive Peak Forward Surge Current 30

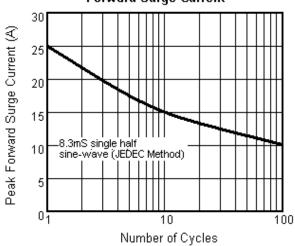


Fig.3 Typical Instantaneous Forward Characteristics

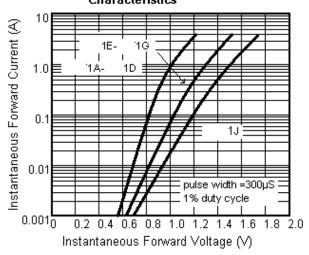
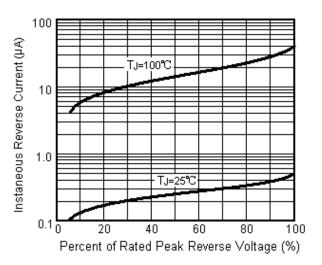


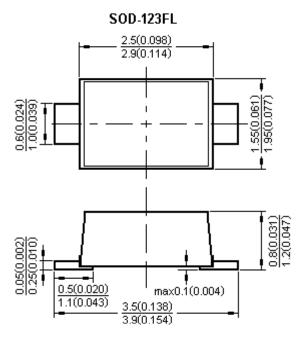
Fig.4 Typical Reverse Characteristics



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## **Package Outline**



Dimensions in millimeters and (inches)

### **Notice**

- Product is intended for use in general electronics applications.
- Product should be worked less than the ratings; if exceeded, may cause permanent damage.or introduce latent failure mechanisms.
- The absolute maximum ratings are rated values and must not be exceeded during operation. The following are the general derating methods you design a circuit with a device.
  - $I_{\text{F(AV)}}\!:\!\text{We recommend that the worst case current be no greater than 80%}$  .
  - $T_J$ : Derate this rating when using a device in order to ensure high reliability. We recommend that the device be used at a  $T_J$  of below 125°C.

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